L Number	Hits	Search Text	DB	Time stamp
1 Number	231958		USPAT;	2003/04/15 14:50
-	231930	l light emitting, (light hear emitting	US-PGPUB;	2003/04/13 14.50
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
1,	99034	(light switting) (light same switting) and	l —	2003/04/15 14:51
2	99034	1 , 3	USPAT;	2003/04/15 14:51
		optical	US-PGPUB;	
!			EPO; JPO;	1
i			DERWENT;	
i	40000		IBM_TDB	0000/04/15 14 50
3	40288	1 , ,	USPAT;	2003/04/15 14:52
1		and optical) and (recess trench gap cavity	US-PGPUB;	
i		opening groove)	EPO; JPO;	
			DERWENT;	
	16701		IBM_TDB	000040445
4	16721	1 , , , , , , , , , , , , , , , , , , ,	USPAT;	2003/04/15 14:53
l		and optical) and (recess trench gap cavity	US-PGPUB;	
		opening groove)) and sensor	EPO; JPO;	1
			DERWENT;	İ
			IBM_TDB	
5	12603	1 () ()	USPAT;	2003/04/15 14:55
		and optical) and (recess trench gap cavity	US-PGPUB;	
		opening groove)) and sensor) and	EPO; JPO;	Ī
		(substrate wafer base (auxiliary near	DERWENT;	Į.
		carrier))	IBM_TDB	
6	7181	(((((light-emitting) (light near emitting)	USPAT;	2003/04/15 14:59
		and optical) and (recess trench gap cavity	US-PGPUB;	
		opening groove)) and sensor) and	EPO; JPO;	
		(substrate wafer base (auxiliary near	DERWENT;	
		carrier))) and lens	IBM_TDB	
8	3459		USPAT;	2003/04/15 14:59
		emitting) and optical) and (recess trench	US-PGPUB;	
		gap cavity opening groove)) and sensor)	EPO; JPO;	
		and (substrate wafer base (auxiliary near	DERWENT;	
		carrier))) and lens) and (housing package)	IBM_TDB	

L Number	Hits	Search Text	DB	Time stamp
1	231958	light-emitting) (light near emitting	USPAT;	2003/04/15 14:50
			US-PGPUB;	
1 1			EPO; JPO;	
			DERWENT;	
			IBM TDB	ļ i
2	99034	(light-emitting) (light near emitting) and	USPAT;	2003/04/15 14:51
-		optical	US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
3	40288	((light-emitting) (light near emitting)	USPAT;	2003/04/15 14:52
		and optical) and (recess trench gap cavity	US-PGPUB;	
		opening groove)	EPO; JPO;	
			DERWENT;	!
			IBM TDB	!
4	16721	(((light-emitting) (light near emitting)	USPAT;	2003/04/15 14:53
_		and optical) and (recess trench gap cavity	US-PGPUB;	
!		opening groove)) and sensor	EPO; JPO;	
			DERWENT;	
			IBM TDB	
5	12603	((((light-emitting) (light near emitting)	USPĀT;	2003/04/15 14:55
		and optical) and (recess trench gap cavity	US-PGPUB;	
		opening groove)) and sensor) and	EPO; JPO;	
		(substrate wafer base (auxiliary near	DERWENT;	
		carrier))	IBM TDB	
6	7181	l ' '	USPAT;	2003/04/15 14:59
		and optical) and (recess trench gap cavity	US-PGPUB;	
		opening groove)) and sensor) and	EPO; JPO;	
		(substrate wafer base (auxiliary near	DERWENT;	
		carrier))) and lens	IBM TDB	
8	3459		USPAT;	2003/04/15 15:00
-		emitting) and optical) and (recess trench	US-PGPUB;	
		gap cavity opening groove)) and sensor)	EPO; JPO;	
-		and (substrate wafer base (auxiliary near	DERWENT;	
		carrier))) and lens) and (housing package)	IBM TDB	
9	161		USPĀT;	2003/04/15 15:01
		emitting) and optical) and (recess trench	US-PGPUB;	
		<pre>gap cavity opening groove)) and sensor)</pre>	EPO; JPO;	
		and (substrate wafer base (auxiliary near	DERWENT;	
		carrier))) and lens) and (housing	IBM TDB	
		package)) and (spherical near lens)	_	

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